

Title (en)

METHOD FOR ENCASING ELECTRONIC COMPONENTS AND INTEGRATED CIRCUITS

Title (de)

VERFAHREN ZUR VERKAPSELUNG ELEKTRONISCHER BAUELEMENTE UND INTEGRIERTER SCHALTUNGEN

Title (fr)

PROCÉDÉ D'ENCAPSULATION DE COMPOSANTS ÉLECTRONIQUES ET DE CIRCUITS INTÉGRÉS

Publication

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Application

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Abstract (en)

[origin: WO2008009328A1] The invention relates to the field of electronic components and the integrated driver circuits and/or control circuits assigned thereto, more particularly to the mechanical encasing of electronic components and the encasing of electronic components and the associated integrated driver circuits and/or control circuits thereof.

IPC 8 full level

**H01L 23/053** (2006.01)

CPC (source: EP KR US)

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